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PTO/SB/05 (4/98)
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UTILITY PATENT APPLICATION TRANSMITTAL

(Only for new non-provisional applications under 37 C.F.R. § 1.53(B))

Attorney Docket No.	R11.12-0735
First Inventor or Application Identifier	David A. Broden et al.
Title	PRESSURE TRANSMITTER FOR CLEAN ENVIRONMENTS
Express Mail Label No.	EL636045645US

APPLICATION ELEMENTS

See MPEP chapter 600 concerning utility patent application contents.

1. ☐ *Fee Transmittal Form e.g., PTO/SB17) (Submit an original and a duplicate for fee processing)*
2. ☒ Specification *[Total Sheets* [18] *]*
   (preferred arrangement set forth below
   - Descriptive title of the Invention)
   - Cross References to Related Applications
   - Statement Regarding Fed sponsored R & D
   - Reference to Microfiche Appendix
   - Background of the Invention
   - Brief Summary of the Invention
   - Brief Description of the Drawings *(if filed)*
   - Detailed Description
   - Claim(s)
   - Abstract of the Disclosure
3. ☒ Drawing(s) *(35 U.S.C. 113)* *[Total Sheets* [6] *]*
4. Oath or Declaration *[Total Sheets* [2] *]*
   a. ☒ Unexecuted (original or copy)
   b. ☐ Copy from a prior application (37 C.F R. § 1.63(d)) *(for continuation/divisional with Box 16 completed)*
      i. ☐ DELETION OF INVENTOR(S) Signed statement attached deleting inventor(s) named in the prior application, see 37 C.F.R. §§1.63(d)(2) and 1.33(b).

** NOTE FOR ITEMS 1 & 13: IN ORDER TO BE ENTITLED TO PAY SMALL ENTITY FEES, A SMALL ENTITY STATEMENT IS REQUIRED (37 C.F.R. § 1.27), EXCEPT IF ONE FILED IN A PRIOR APPLICATION IS RELIED UPON (37 C.F.R. § 1.28).*

Address To: **Assistant Commissioner for Patents, Box Patent Application, Washington, DC 20231**

5. ☐ Microfiche Computer Program *(Appendix)*
6. ☐ Nucleotide and/or Amino Acid Sequence Submission *(If applicable, all necessary)*
   a. ☐ Computer Readable Copy
   b. ☐ Paper Copy (Identical to computer copy)
   c. ☐ Statement verifying identity of above copies

ACCOMPANYING APPLICATION PARTS

7. ☐ Assignment Papers (cover sheet & document(s))
8. ☐ 37 C.F.R. § 3.73(b) Statement *(when there is an assignee)* ☒ Power of Attorney
9. ☐ English Translation Document
10. ☐ Information Disclosure Statement (IDS/PTO – PTO) ☐ Copies of IDS
11. ☐ Preliminary Amendment
12. ☒ Return Receipt Postcard (MPEP 503)
13. ☐ *Small Entity Statement(s) *(PTO/SB/09-12)* ☐ Statement filed in prior application. Status still proper and desired
14. ☐ Certified Copy of Priority Document(s) *(if foreign priority is claimed)*
15. ☐ Other: ----------

16. **If a CONTINUING APPLICATION,** *check appropriate box, and supply the requisite information below and in a preliminary amendment:*

☐ Continuation ☐ Divisional ☐ Continuation –in part (CIP) of prior application No: _____

Prior application information: *Examiner* _____ *Group/Art Unit:* ____

FOR CONTINUATION or DIVISIONAL APPS only: The entire disclosure of the prior application, from which an oath or declaration is supplied under Box 4b, is considered a part of the disclosure of the accompanying continuation or divisional application and is hereby incorporated by reference. The incorporation can only be relied upon when a portion has been inadvertently omitted from the submitted application parts.

17. CORRESPONDENCE

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Signature		Date	07/07/00

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7-10-00 A

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PATENT AGENT

July 7, 2000

Express Mailing No. : EL636045645US

Assistant Commissioner for Patents
Washington, D.C. 20231

Re: New U.S. Patent Application of:
Applicant: David A. Broden et al.
For : PRESSURE TRANSMITTER FOR CLEAN ENVIRONMENTS
Our File : R11.12-0735

Dear Sir:

Enclosed for filing are the following papers in connection with the above-identified patent application:

1. Complete specification and claims.
   12 pages Specification
   5 pages claims
   1 page Abstract
2. Unexecuted Combined Declaration and Power of Attorney (2 pages).
3. 6 sheets of drawings.

The filing fee is not enclosed with this communication. Pursuant to 35 USC § 111 and 37 CFR §§ 1.53(b) and 1.53(f), the filing fee, executed Declaration will be filed separately.

A filing date under 37 CFR §§ 1.10(b) and 1.53(b) of **July 7, 2000** is respectfully requested. The enclosed materials are being sent "Express Mail Post Office to Addressee" as of the date of this letter.

Yours very truly,

Christopher R. Christenson
Reg. No. 42,413

CRC:ajm
Encs.

Express Mail No. EL636045645US

PATENT APPLICATION OF

DAVID A. BRODEN AND A. JOSEPH STANLEY

ENTITLED

PRESSURE TRANSMITTER FOR CLEAN ENVIRONMENTS

Docket No. R11.12-0735

PRESSURE TRANSMITTER FOR CLEAN ENVIRONMENTS

BACKGROUND OF THE INVENTION

This invention relates generally to pressure transmitters. More particularly, the present invention relates to a pressure transmitter for use in clean environments.

Certain industrial processes require relatively clean processing environments compared to general manufacturing processes. Examples of such clean processes include semiconductor manufacturing, pharmaceutical manufacturing, and food processing. In such environments, it becomes very important to ensure that all processing equipment can perform its required function without contaminating the process.

One device that has become highly useful in industrial processing environments is the pressure transmitter. A pressure transmitter is a device that senses fluid pressure within a process and provides an electrical signal indicative of the pressure to a control system. Generally, pressure transmitters have a pressure sensor that includes a deflectable diaphragm that deflects in direct response to pressure applied thereto, and which has an electrical structure on the diaphragm that varies its electrical characteristic in response to diaphragm deflection and thus pressure. Pressure transmitters that use a capacitive pressure sensor, are generally filled with a dielectric fill fluid that increases the capacitance of the pressure sensor to increase sensor

resolution. However, in the event that such a sensor were to develop a leak, the dielectric fill fluid, which is occasionally silicone oil, would spill into the system thus contaminating the product. Therefore, industrial processes which require very clean environments generally do not tolerate pressure sensors that use a fill fluid. Thus, pressure transmitters designed for such clean environments are generally required to sense process fluid pressure without the benefit of a fill fluid.

Although a number of pressure transmitters are known for clean environments, there is an ongoing need to provide simply and cost effective pressure transmitters for use in clean environments.

SUMMARY OF THE INVENTION

A pressure transmitter for clean processing environments is disclosed. The pressure transmitter includes a process connector, a weld ring, a pressure sensor module, a frame, and a housing. The process connector is coupleable to a source of process fluid and directs process fluid to the pressure sensor module. The process connector is sealed to the pressure sensor module to couple process fluid to the pressure sensor. A weld ring is disposed about the pressure sensor module and provides a secondary process fluid seal. The pressure sensor module is electrically coupled to measurement circuitry to provide digital data indicative of process fluid pressure. The frame is coupled to the weld ring and

the housing is coupleable to the frame and weld ring such that the housing rests upon the weld ring when secured in place.

The pressure sensor module includes an isolator diaphragm that is operably coupled to a pressure sensor. The pressure sensor can include a deflectable silicon diaphragm having elements thereon that provide an electrical characteristic that varies with diaphragm deflection. The isolating diaphragm and deflectable diaphragm are separated from one another by a filler material. The filler material can be a polyurethane.

BRIEF DESCRIPTION OF THE DRAWINGS

Fig. 1 is a diagrammatic view of a portion of a process control and measurement system.

Fig. 2 is a perspective exploded view of a pressure transmitter in accordance with an embodiment of the present invention.

Fig. 3 is a system block diagram of a pressure transmitter in accordance with an embodiment of the present invention.

Fig. 4 is a side sectional view of a sensor module in accordance with an embodiment of the present invention.

Fig. 5 is a perspective view of a dead end process connector.

Figs. 6a and 6b are perspective views of pressure transmitters in accordance with embodiments of the present invention.

Fig. 7 is a perspective view of a weld ring in accordance with an embodiment of the present invention.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

Fig. 1 is a diagrammatic view of a portion of a process control and measurement system 10 that includes controller 12 coupled to high purity pressure transmitter 14 (HPT) via process communication loop 16. As illustrated, HPT 14 is coupled to fluid source 18 to receive process fluid and provide an indication of fluid pressure. HPT 14 is shown with a flow-through design since fluid from process fluid source 18 flows through HPT 14. Other embodiments where fluid does not flow through the HPT will be discussed later in the specification. Although a pair of conductors are illustrated diagrammatically connecting controller 12 to HPT 14, any suitable number of conductors may be used. Further, any suitable process communication protocol can be used to communicate between HPT 14 and controller 12 including, for example, the Highway Addressable Remote Transducer (HART®), FOUNDATION™ Fieldbus, or any other suitable protocol. Essentially, HPT 14 provides an indication to controller 12 of the pressure of process fluid flowing therethrough. HPT 14 performs such measurement in a manner that does not risk contaminating the process fluid flowing therethrough.

Fig. 2 is a perspective exploded view of HPT 14 in accordance with embodiments of the present invention. HPT 14 is shown having fasteners 20 removed so that housing 22 can be lifted to expose the interior of HPT 14. Connector 24 is coupled to frame 26 and remains below its mating hole 28 when enclosure 22 is lifted. Preferably, connector 24 is a Bendix™ connector. Frame 26 includes a pair of arms 30 that extend between ends 32 and 34. Standoffs 36 support multiple printed circuit boards 38, 40, which, in turn, support various circuits associated with HPT 14. Frame 26 is mounted to weld ring 42 which is preferably constructed from type 316L ferrite #3 - 10 stainless steel. Weld ring 42 includes an annular lip 44 that contacts bottom surface 45 of housing 22 when housing 22 is fully seated downwardly. Weld ring 42 surrounds and mounts sensor module 46 which sits atop process connector 48.

Preferably, all components of HPT 14 are selected in accordance with the requirements of Semiconductor Equipment and Materials International Standards (SEMI). Thus, process connector 48 is preferably type 316 L stainless steel Vacuum Arc Remelt (VAR). Likewise, the diaphragm within sensor module 46 (not shown) is preferably constructed from the same material. Housing 22 is formed from type 304 stainless steel, and frame 26 is preferably constructed from aluminum or plastic. Those skilled

in the art will appreciate that a number of materials may be selected in accordance with SEMI, and that the above noted materials are merely one specific combination thereof.

Process connector 48 is machined and smoothed by honing to get a minimum surface roughness value of 10 Ra. Sensor module 46 and weld ring 42 are welded together to form a sensor/weld ring assembly that is electro-polished before or after the weld process to ensure that a surface finish of less than 7 Ra is achieved, and to further ensure that the required metallurgy is present on the surface. Frame 26 is then affixed to weld ring 42 after which circuit cards 38, 40 are mounted upon frame 26. Once cards 38, 40 are so mounted, electrical connections between sensor module 46 and circuit cards 38, 40 are effected. Preferably, such electrical connections are via flex cable. Next, connector 24 is positioned on top of frame 26 and is electrically coupled to circuit cards 38, 40 via a multi-wire electrical cable. Once connector 24 is so coupled, housing 22 is assembled and screws 20 are used to secure housing 22 and connector 24 to frame 26.

Fig. 3 is a system block diagram of HPT 14 in accordance with the present invention. HPT 14 includes power module 50 and loop communicator 52, each of which is adapted to couple to process communication loop 16. Power module 50 receives energy from loop 16 and provides electrical power to

all components of HPT 14 as indicated by arrow 54 labeled to all. Loop communicator 52 is also coupleable to process communication loop 16 and is adapted for bi-directional communication over loop 16. Loop communicator 52 is coupled to controller 56 such that loop communicator 52 can provide data to controller 56 indicative of process communication signals received from loop 16. Conversely, loop communicator 52 can receive data from controller 56 and generate suitable process communication signals on loop 16. Controller 56 is coupled to measurement circuitry 58 which is, in turn, coupled to sensor 60. In the preferred embodiment, sensor 60 is a piezoresistive element that has an electrical property which varies with diaphragm deflection. A more detailed description of sensor 60 will be described with respect to Fig. 4. Measurement circuitry 58 includes suitable circuitry to measure the varying electrical characteristic of sensor 60 and provide data to controller 56 indicative of process fluid pressure. Preferably, measurement circuitry 58 includes an analog-to-digital converter adapted to convert a voltage indicative of the pressure acting upon sensor 60, into digital data that is transmitted to controller 56.

Fig. 4 is a side sectional view of sensor module 46 in accordance with an embodiment of the present invention. Sensor module 46 includes header assembly 70 which has a plurality of bores 72

extending therethrough to allow connection posts 74 to pass through. Sensor module 46 includes isolating diaphragm 76 that is welded to ring member 78 which is coupled to header assembly 70. Isolating diaphragm 76 is preferably constructed from type 316L VAR stainless steel. Isolating diaphragm 76 is coupled to sensor 80 via filler material 82. Process fluid acts upon isolator diaphragm 76 in the direction of arrow 84. Such pressure is transmitted through filler material 82 and causes sensor 80 to deflect. Sensor 80 preferably includes a deflectable silicon diaphragm having one or more piezoresistors disposed on at least one surface, which have an electrical characteristic that varies in response to sensor deflection. Such piezoresistors are well known in the art. Passthrough connector 74 is coupled to bonding wire 86 such that passthrough connector 74 allow electrical access to the piezoresistors disposed on sensor 80. Sensor module 46 also includes tube 88 which initially is in fluidic communication with the opposite side of sensor 80. By venting tube 88 to atmospheric pressure, sensor module 46 can be adapted to sense gage pressure. Additionally, in some embodiments, a vacuum is coupled to tube 88 which is then sealed such that a permanent vacuum exists within sensor module 46 thus transforming sensor module 46 into an absolute pressure sensor.

Sensor 80 is disposed proximate pedestal 90. The top side of pedestal 90 is preferably bonded to header assembly 70 via a suitable bond 92. Spacer 94 is also disposed within sensor module 46.

The selection of filler material 82 is relatively important for the long term viability of sensor module 46. For example, if material 82 is too rigid, it will counteract, to some extent, the pressure forces of the process fluid, thereby reducing the sensitivity of sensor module 46. Additionally, if the adhesive bonds between filler material 82 and sensor 80, or between filler material 82 and isolator diaphragm 76 should disengage, or otherwise delaminate, such condition can introduce undesirable errors since deflection of isolator diaphragm 76 may not necessarily result in the appropriate deflection of sensor 80. Further still, it is important that the mechanical characteristics of filler 82 be relatively stable over the thermal operating range of HPT 14 such that temperature does not introduce unwanted variance into pressure measurement. Finally, a selection of filler material 82 should facilitate quick and robust manufacture of sensor module 46 such that high yields can be achieved while minimizing manufacturing costs.

A number of different elastomers have been tested as filler material 82. Such materials include Conathane DPEN-15631 Blue available from (Conap, Inc. of Olean, New York); RTVS 27; GE 630 (available from

GE Silicones, of (Waterford, New York); Oxy-Bond 1214 (Resin Technology Group, LLC. of South Easton, Massachusetts); Master Bond EP30-FL (available from Master Bond Inc. of Hackensack, New Jersey); Insulcast 781 (available from Permagile Industries Inc. of Plainview, New York); Insulgel 50 (available from Permagile Industries Inc.); Conathane EN-11 (Conap Inc.); Conathane EN-7 (available from Conap Inc.); Biwax 821051 (available from Loctite Corporation, of Commerce City, Colorado); and Conathane EN-2523 (available from Conap Inc.). However, two specific substances proved superior for the function of filler 82. Specifically, polyether aromatic polyurethane having a durometer of approximately 91 Shore A, proved superior. Examples of such polyurethane include ST-1890-91, and ST-1880-87 (both of which are available from Steven's Urethane of Holyoke, Massachusetts). Using the preferred polyurethane as filler 82, which is generally shipped in sheet form, portions can be cut that fit precisely into module 46 before the isolator diaphragm assembly is mounted thereto. Subsequently, pressure is applied to isolator diaphragm 76 and sensor module 46 is heated to approximately 200 degrees Celsius to cause the polyurethane to flow. As filler material 82 cools, it bonds to sensor 82 and isolator diaphragm 76. Preferably, approximately 20 pounds per square inch of pressure is applied to isolator diaphragm 76 during the heating process.

The resulting filler 82 is stable over a wide temperature range and appears to enhance a sensor of longevity.

Fig. 5 is a perspective view of dead end process connector 96. For embodiments where flow through pressure measurement is not required, dead end process connector 96 is substituted for flow through process connector 48 resulting in an assemblies that appear in Figs. 6A and 6B. Aside from the different process connector, the transmitters shown in Figs 6A and 6B are the same as that shown in Fig. 1.

Figs. 6A and 6B illustrate transmitters that incorporate the dead end process fluid connector 96 shown in Fig. 5. It should be noted that other process fluid connectors such as a modular connector can also be used with embodiments of the present invention. As shown in Figs. 6A and 6B, the transmitters can include VCR fittings (male in Fig. 6A and female in Fig. 6B). However, a variety of other suitable process fittings can also be used.

Fig. 7 is a perspective view of weld ring 42. As can be seen in Fig. 7, weld ring 42 includes annular lip portion 44 upon which surface 46 of housing 42 rests. Additionally, Fig. 7 shows a plurality of mounting holes 98 which facilitate mounting frame 26 thereon. As illustrated, weld ring 42 includes internal bore 100 that is sized to fit over sensor module 46. Additionally, weld ring 42

also includes flared portion 102 that flares from outer diameter 104 of weld ring 42 to annular lip portion 44. By providing flared portion 102, weld ring 42 can provide the function of creating a second process fluid seal, while simultaneously providing a surface upon which housing 22 can mount.

Although the present invention has been described with reference to preferred embodiments, workers skilled in the art will recognize that changes may be made in form and detail without departing from the spirit and scope of the invention.

WHAT IS CLAIMED IS:

1. A pressure transmitter for a clean environment, the pressure transmitter comprising:

a process coupling coupleable to a source of process fluid;

a pressure sensor module coupled to the process coupling for fluidic communication with the process fluid, the pressure sensor module having an electrical characteristic that varies with process fluid pressure;

measurement circuitry operably coupled to the pressure sensor module, the measurement circuitry being adapted to provide a signal based upon at least one measurement of the electrical characteristic;

communication circuitry coupled to the measurement circuitry and adapted to provide pressure-related information to a process control loop; and

wherein the pressure transmitter further comprises a weld ring welded to the process coupling and disposed about the pressure sensor module to provide a secondary seal for the process fluid, the weld ring extending outwardly from an outer diameter of the weld ring.

2. The transmitter of claim 1, wherein the weld ring is adapted to couple to a housing.

3. The transmitter of claim 1, wherein the weld ring is constructed type 316L ferrite #3-10 stainless steel.

4. A pressure transmitter for a clean environment, the pressure transmitter comprising:

a process coupling coupleable to a source of process fluid;

a pressure sensor module coupled to the process coupling for fluidic communication with the process fluid, the pressure sensor module having an electrical characteristic that varies with process fluid pressure;

measurement circuitry operably coupled to the pressure sensor module, the measurement circuitry being adapted to provide a signal based upon at least one measurement of the electrical characteristic;

communication circuitry coupled to the measurement circuitry and adapted to provide pressure-related information to a process control loop; and

wherein the pressure sensor module further includes:

an isolator diaphragm positioned to contact the process fluid;

a deflectable sensor diaphragm pressure sensor disposed within the pressure sensor module; and

filler material disposed between the isolator diaphragm and the sensor diaphragm, wherein the filler material is constructed from an elastomer.

5. The transmitter of claim 4, wherein the elastomer is polyurethane.

6. The transmitter of claim 5, wherein the polyurethane filler material is polyether aromatic polyurethane.

7. The transmitter of claim 5, wherein the filler material is ST-1890-91 polyurethane.

8. The transmitter of claim 5, wherein the filler material is ST-1880-87 polyurethane.

9. The transmitter of claim 4, wherein the filler is bonded to both the isolator diaphragm and the sensor diaphragm.

10. A pressure sensor module for a pressure transmitter, the pressure sensor module comprising:

a header assembly;

a deflectable sensor diaphragm mounted relative to the header assembly, the deflectable sensor diaphragm having at least one element disposed on the diaphragm having an electrical characteristic that varies with diaphragm deflection;

an isolator diaphragm coupled to the header assembly and adapted for contact with process fluid, the isolator diaphragm operable coupled to the deflectable sensor diaphragm; and

an elastomeric filler material interposed between the isolator diaphragm and the deflectable sensor diaphragm.

11. The transmitter of claim 10, wherein the elastomer is polyurethane.

12. The transmitter of claim 10, wherein the polyurethane filler material is polyether aromatic polyurethane.

13. The transmitter of claim 12, wherein the filler material is ST-1890-91 polyurethane.

14. The transmitter of claim 12, wherein the filler material is ST-1880-87 polyurethane.

15. The transmitter of claim 10, wherein the filler is bonded to both the isolator diaphragm and the sensor diaphragm.

16. A pressure transmitter for a clean environment, the transmitter comprising:

a process coupleable to a source of process fluid;

means for sensing process fluid pressure, the means for sensing coupled to the process coupling;

measurement circuitry coupled to the pressure sensing means, the measurement circuitry being adapted to provide a signal based upon at least one measurement of an electrical characteristic of the pressure sensing means; and

a communication circuit coupled to the measurement circuitry and adapted to provide pressure-related information over a process control loop.

PRESSURE TRANSMITTER FOR CLEAN ENVIRONMENTS

ABSTRACT

A pressure transmitter for clean processing environments is disclosed. The pressure transmitter includes a process connector, a weld ring, a pressure sensor module, a frame, and a housing. The process connector is coupleable to a source of process fluid and directs process fluid to the pressure sensor module. The process connector is sealed to the pressure sensor module to couple process fluid to the pressure sensor. A weld ring is disposed about the pressure sensor module and provides a secondary process fluid seal. The pressure sensor module is electrically coupled to measurement circuitry to provide digital data indicative of process fluid pressure. The frame is coupled to the weld ring and the housing is coupleable to the frame and weld ring such that the housing rests upon the weld ring when secured in place. The pressure sensor module includes an isolator diaphragm that is operably coupled to a pressure sensor. The pressure sensor includes deflectable sensor diaphragm having elements thereon that provide an electrical characteristic that varies with diaphragm deflection. The isolating diaphragm and pressure sensor are separated from one another by a filler material. The filler material can be a polyurethane.

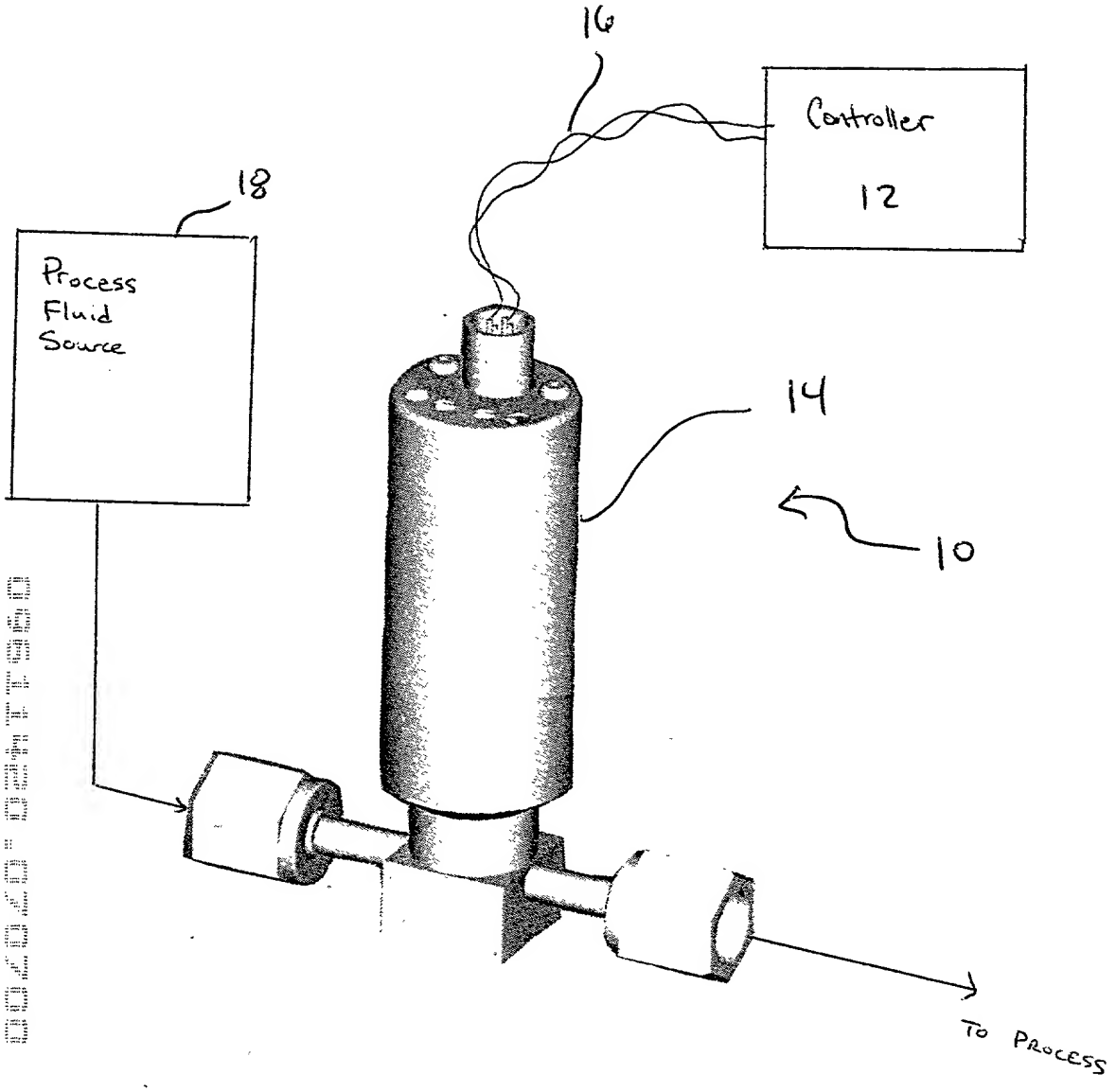

FIG. 1

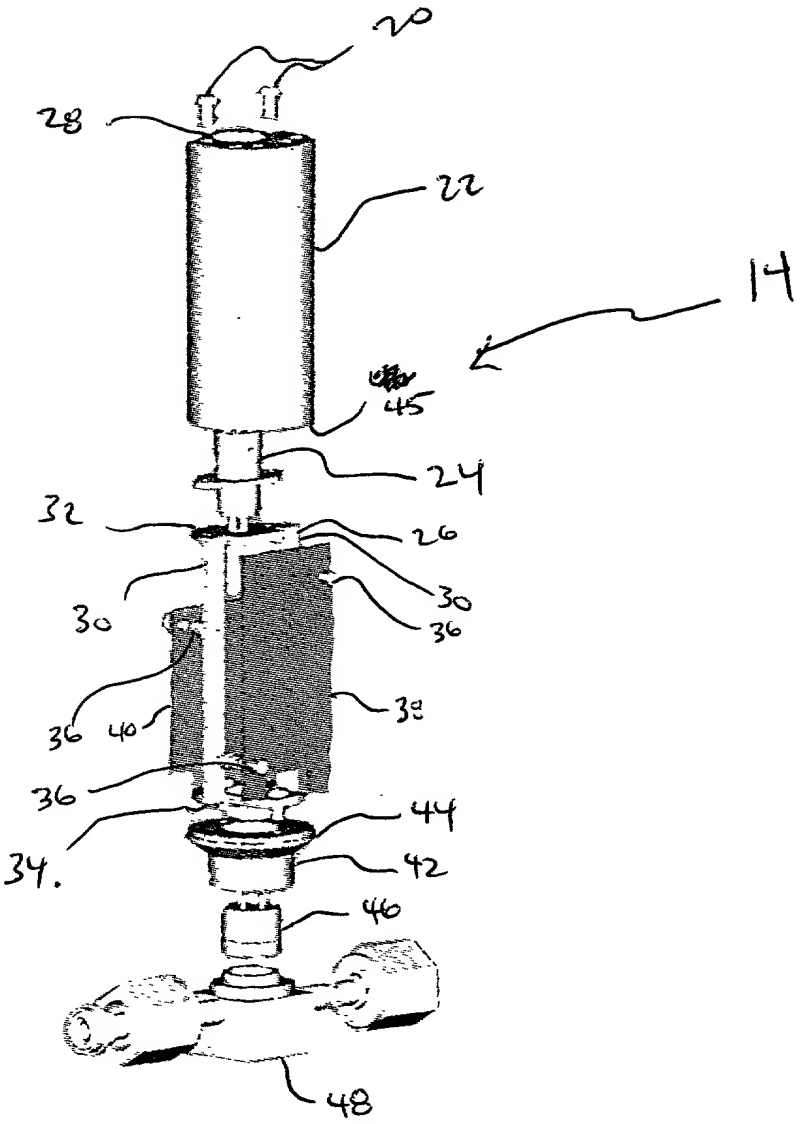

FIG. 2

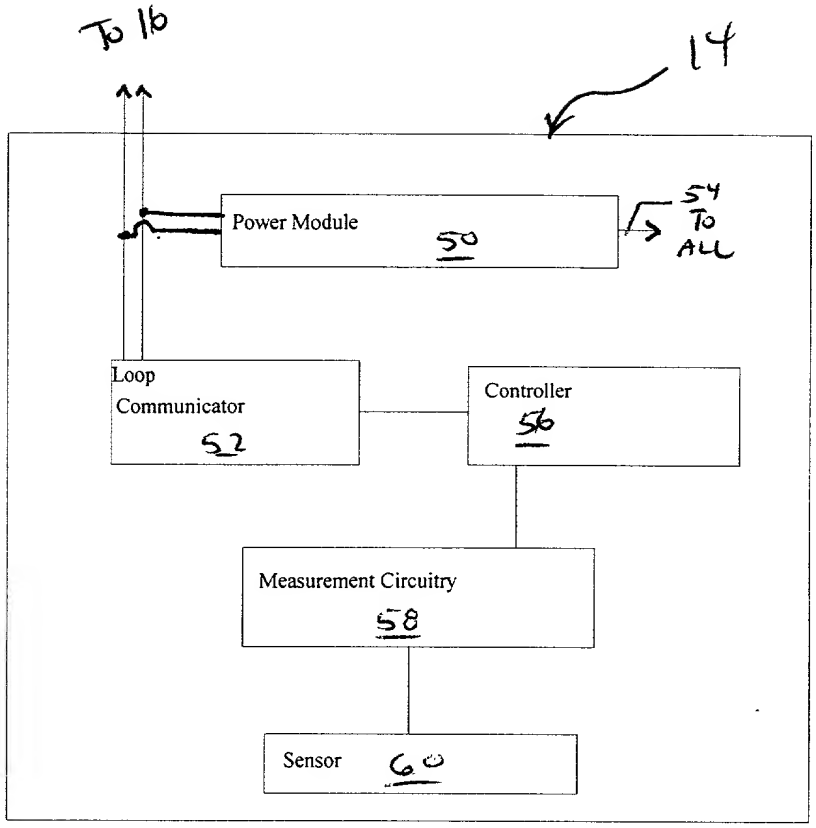
To 16
14
Power Module
50
54
To
ALL
Loop
Communicator
52
Controller
56
Measurement Circuitry
58
Sensor
60

FIG. 3

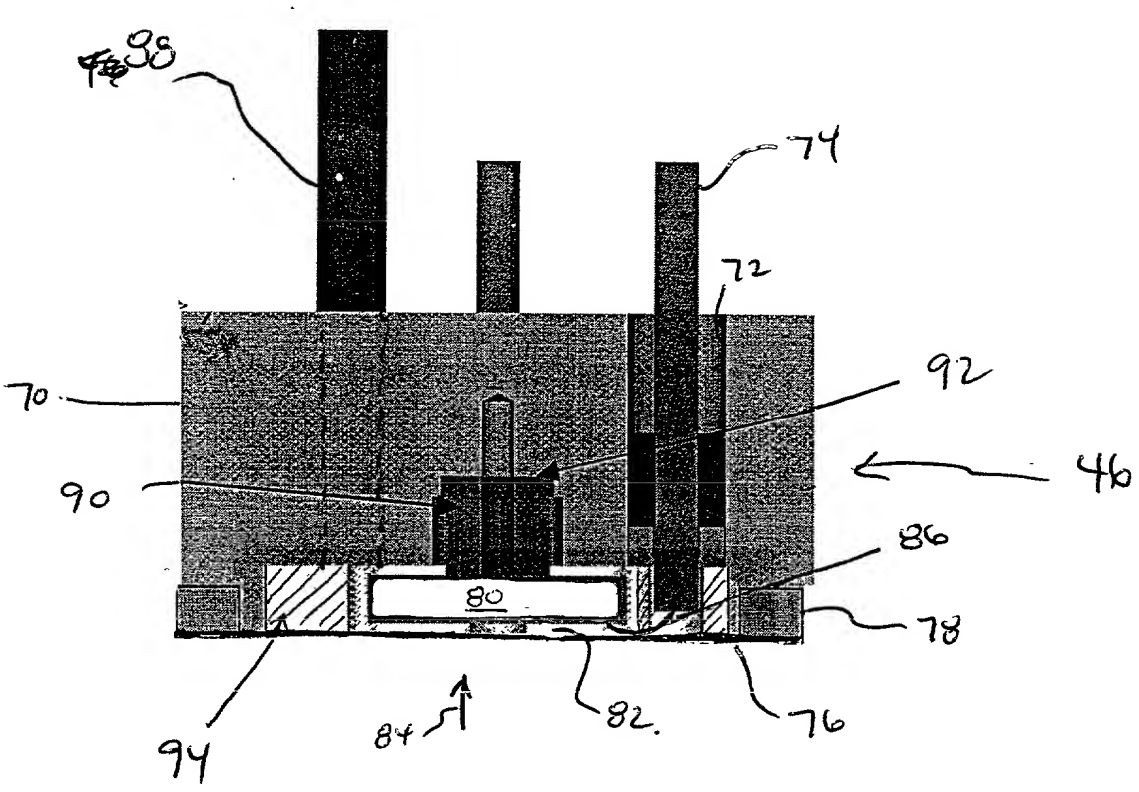

FIG. 4

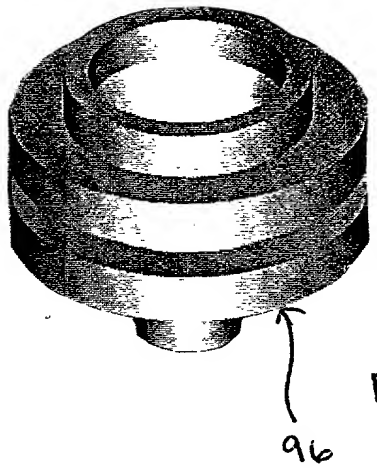

FIG. 5

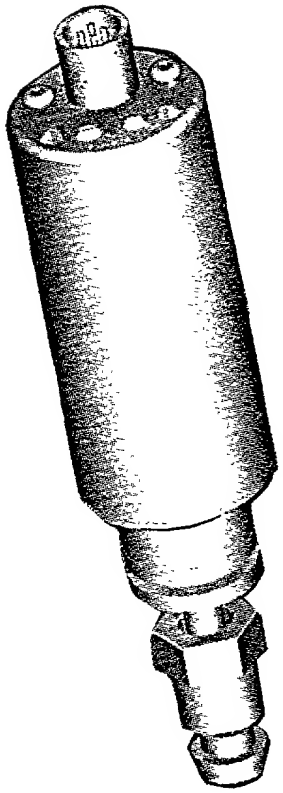

FIG. 6A

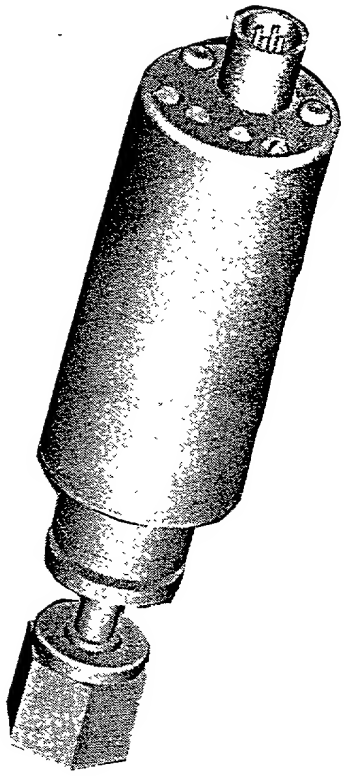

FIG. 6B

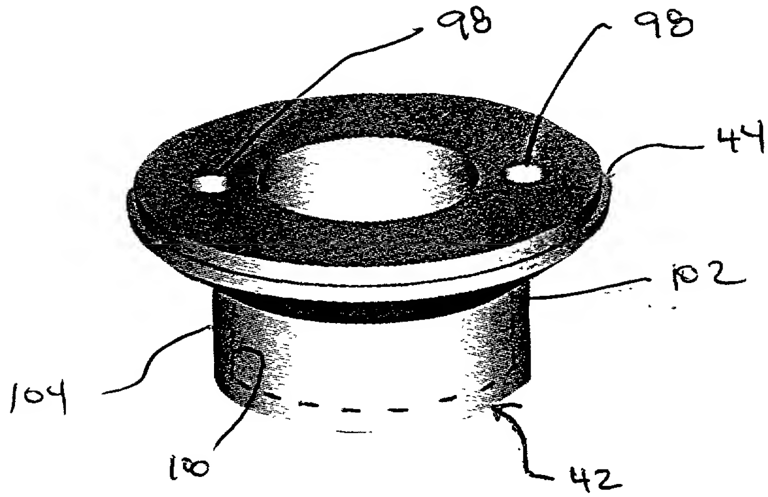

FIG. 7

COMBINED DECLARATION AND POWER OF ATTORNEY

IN ORIGINAL APPLICATION

Attorney Docket No.

R11.12-0735

SPECIFICATION AND INVENTORSHIP IDENTIFICATION

As a below named inventor, I declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and joint inventor of the subject matter which is claimed, and for which a patent is sought, on the invention entitled "CLOSE PROXIMITY MATERIAL INTERFACE DETECTION FOR A MICROWAVE LEVEL TRANSMITTER" the specification of which,

(check one) _X_ is attached hereto.
___ was filed on _ as Appln. Serial No. _.
___ and was amended on _.
___ was described and claimed in PCT International Application No. _ filed on _ and as amended under PCT Article 19 on _.

ACKNOWLEDGEMENT OF REVIEW OF PAPERS AND DUTY OF CANDOR

I have reviewed and understand the contents of the above identified specification, including the claims, as amended by all amendment referred to above. I acknowledge the duty to disclose information which is known to me to be material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56.

PRIORITY CLAIM (35 USC § 120)

I claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below. Insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35 United States Code § 112, I acknowledge the duty to disclose to the Patent Office all information known to me to be material to patentability as defined in Title 37 Code of Federal Regulations § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

Appln. Ser. No.	U.S. Serial No. (if any under PCT)	Filing Date	Status

DECLARATION

I declare that all statements made herein that are of my own knowledge are true and that all statements that are made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorneys and/or agents to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith: Nickolas E. Westman, Reg. No. 20,147; Joseph R. Kelly, Reg. No. 34,847; and Judson K. Champlin, Reg. No. 34,797; Steven M. Koehler, Reg. No. 36,188; David D. Brush, Reg. No. 34,557; John D. Veldhuis-Kroeze, Reg. No. 38,354; Deirdre Megley Kvale, Reg. No. 35,612; Theodore M. Magee, Reg. No. 39,758; Peter S. Dardi, Reg. No. 39,650; Christopher R. Christenson, Reg. No. 42,413; John A. Wiberg, Reg. No. 44,401; and Brian D. Kaul, Reg. No. 41,885.

I ratify all prior actions taken by Westman, Champlin & Kelly, P.A. or the attorneys and agents mentioned above in connection with the prosecution of the above-mentioned patent application.

DESIGNATION OF CORRESPONDENCE ADDRESS

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